Single and dual-channel passive filter network with ESD protection

Rev. 1 — 23 July 2010

Product data sheet

1. Product profile

1.1 General description

The IP4256CZ3-M is a single-channel low-pass filter while the IP4256CZ5-W and IP4256CZ6-F are dual-channel RC low-pass filters. All devices provide high-level ElectroStatic Discharge (ESD) protection.

The devices are designed to protect a range of portable communication transmitter applications against unwanted RF signals. The devices incorporate diodes to provide protection to downstream components from ESD voltages up to ± 25 kV contact discharge far exceeding IEC 61000-4-2, level 4.

The devices are manufactured using monolithic silicon technology in lead-free plastic packages.

1.2 Features and benefits

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- 100 Ω series channel resistance and 30 pF channel capacitance at 0 V bias voltage (DC)
- ESD protection up to ±25 kV contact discharge far exceeding IEC 61000-4-2, level 4
- Single and dual-channel integrated π-type RC filter network
- IP4256CZ3-M: single-channel device in a 3-pin Quad Flat-pack No-leads (QFN) compatible MicroPak plastic package
- IP4256CZ5-W: dual-channel device in a 5-pin plastic package with 0.5 mm pitch
- IP4256CZ6-F: dual-channel device in a 6-pin QFN compatible MicroPak plastic package with 0.5 mm pitch

1.3 Applications

- General-purpose ElectroMagnetic Interference (EMI), Radio Frequency Interference (RFI) filtering and downstream ESD protection for:
 - Cellular phone and Personal Communication System (PCS) mobile handset
 - Cordless telephone
 - Wireless data (WAN/LAN) system



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1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{ESD}	electrostatic discharge voltage	all pins to ground	<u>[1]</u>			
		contact discharge	-	-	±25	kV
		air discharge	-	-	±25	kV
$R_{s(ch)}$	channel series resistance		80	100	120	Ω
C _{ch}	channel capacitance	for the total channel; f = 100 kHz				
		$V_{bias(DC)} = 0 V$	-	30	-	pF
		$V_{bias(DC)} = 2.5 V$	-	19	-	pF

[1] According to IEC 61000-4-2 model.

2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
IP4256CZ3-	M (SOT883)		
1 and 2	channel 1 filter		_
3	ground (GND)	1 2 3 Transparent top view	$1 \xrightarrow{\text{R}_{S(ch)}} 2$
IP4256CZ5-	W (SOT665)		
1 and 5	channel 1 filter		_
2	ground (GND)		Rs(ch) 1,3 + 4,
3 and 4	channel 2 filter		$\begin{array}{c} & & & \\ & & & & \\ & & & \\ & & & & \\ & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\$
IP4256CZ6-	F (SOT886)		
1 and 6	channel 1 filter		5
2 and 5	ground (GND)		1,3 + 4,
3 and 4	channel 2 filter	6 5 4	$\begin{array}{c} & & & \\ & & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & & \\ & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & & \\ & & & & \\ & & & & & \\ & & & & \\ & & & & \\ & & & & & \\ & & &$

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3. Ordering information

Type number	Package					
	Name	Description	Version			
IP4256CZ3-M	SC-101	leadless ultra small plastic package; 3 solder lands; body 1.0 \times 0.6 \times 0.5 mm	SOT883			
IP4256CZ5-W	-	plastic surface-mounted package; 5 leads	SOT665			
IP4256CZ6-F	XSON-6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886			

4. Marking

Table 4. Marking codes	
Type number	Marking code
IP4256CZ3-M	6M
IP4256CZ5-W	6W
IP4256CZ6-F	6F

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+5.6	V
V _{ESD}	electrostatic discharge	all pins to ground	<u>[1]</u>		
	voltage	contact discharge	-	±25	kV
		air discharge	-	±25	kV
		IEC 61000-4-2, level 4	[2]		
		contact discharge	-	±8	kV
		air discharge	-	±15	kV
P _{ch}	channel power dissipation	T _{amb} = 85 °C	-	60	mW
P _{tot}	total power dissipation	T _{amb} = 85 °C	-	120	mW
T _{stg}	storage temperature		-55	+150	°C
T _{amb}	ambient temperature		-40	+85	°C

[1] According to IEC 61000-4-2 model.

[2] Devices withstand up to 1000 discharges of ±25 kV according to the IEC 61000-4-2 model without degradation and exceeds the specified level 4 (8 kV contact discharge).

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6. Characteristics

Table 6. Channel characteristics

 $T_{amb} = 25 \ ^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{s(ch)}	channel series resistance		80	100	120	Ω
C _{ch}	channel capacitance	for the total channel; f = 100 kHz				
		$V_{bias(DC)} = 0 V$	-	30	-	pF
		$V_{bias(DC)} = 2.5 V$	-	19	-	pF
I _{RM}	reverse leakage current	per channel; $V_I = 3.5 V$	-	-	0.1	μA
V _{BR}	breakdown voltage	positive clamp; I _I = 1 mA	5.8	-	9	V
V _F	forward voltage	negative clamp; $I_F = 1 \text{ mA}$	-1.5	-	+0.4	V

Table 7. Frequency characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$lpha_{il}$ inser	insertion loss	R_{source} = 50 Ω ; R_{L} = 50 Ω				
		800 MHz < f _i < 3 GHz	20	-	-	dB
		f _i = 1 GHz	-	25	-	dB
α_{ct}	crosstalk attenuation	$\begin{array}{l} R_{\text{source}} = 50 \ \Omega; \ R_{L} = 50 \ \Omega; \\ 800 \ MHz < f_{i} < 3 \ GHz \end{array}$	-	25	-	dB

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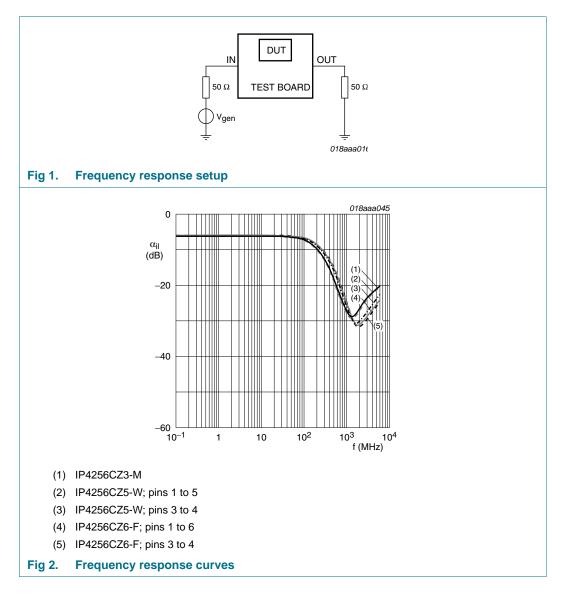
7. Application information

7.1 Insertion loss

The devices are specifically designed as EMI/RFI filters for multichannel interfaces.

The measured insertion loss in a 50 Ω system is shown in Figure 2.

The insertion loss was measured using a test Printed-Circuit Board (PCB) utilizing laser-drilled micro-via holes that connect the PCB ground plane to the ground pins of the device.



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7.2 Example applications

The IP4256CZ3-M, IP4256CZ5-W and IP4256CZ6-F are designed as EMI/RFI filters for multichannel interfaces.

Device selection must be made taking the following into account:

- the maximum clock frequency
- the driver strength and the capacitive load
- the capacitive load of the heat sink
- the maximum applicable rise and fall times

7.2.1 Medium-speed applications: LCD interfaces

The devices can be used with digital interfaces running at clock speeds up to 25 MHz. Typical applications include LCD interfaces.

7.2.2 Low-speed applications: keypads, serial and control interfaces

The devices are ideally suited for applications with low transfer speeds which demand robust ESD protection and strong EMI filtering. This includes keypads, low-speed serial interfaces and low-speed control signals.

The very small footprint of the devices makes it easy to locate the ESD and EMI protection very close to the interface to be protected.

IP4256CZ3-M_CZ5-W_CZ6-F

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8. Package outline

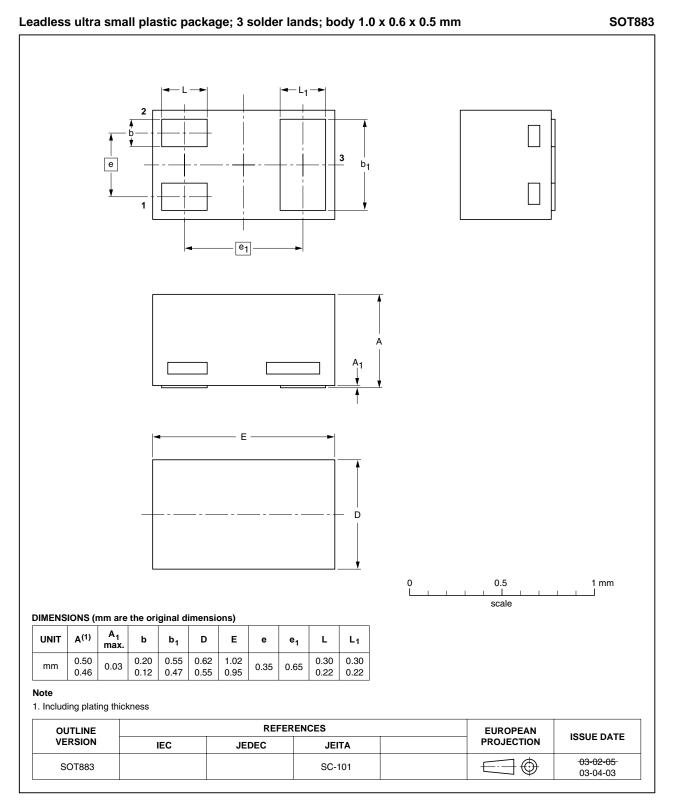


Fig 3. Package outline SOT883 (SC-101)

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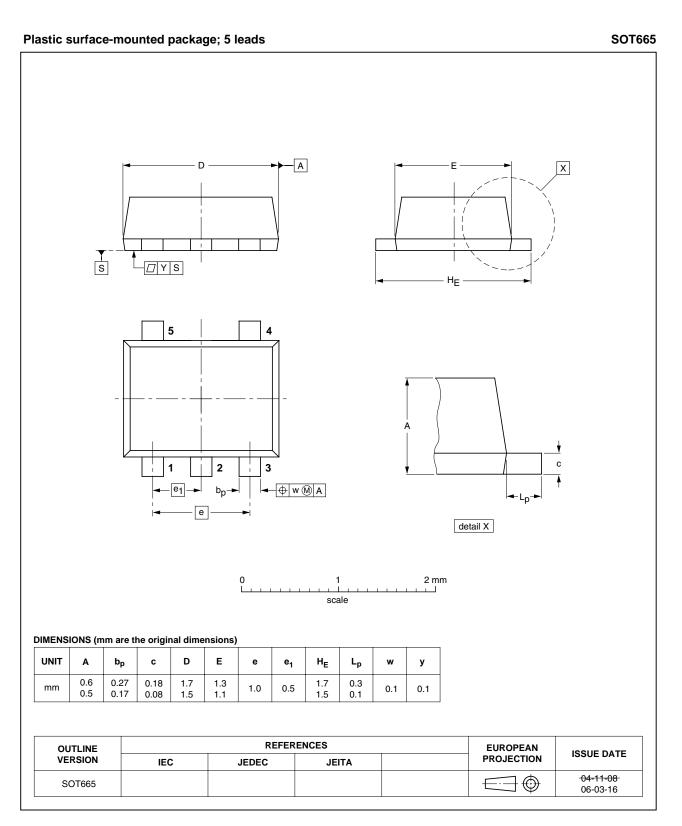


Fig 4. Package outline SOT665

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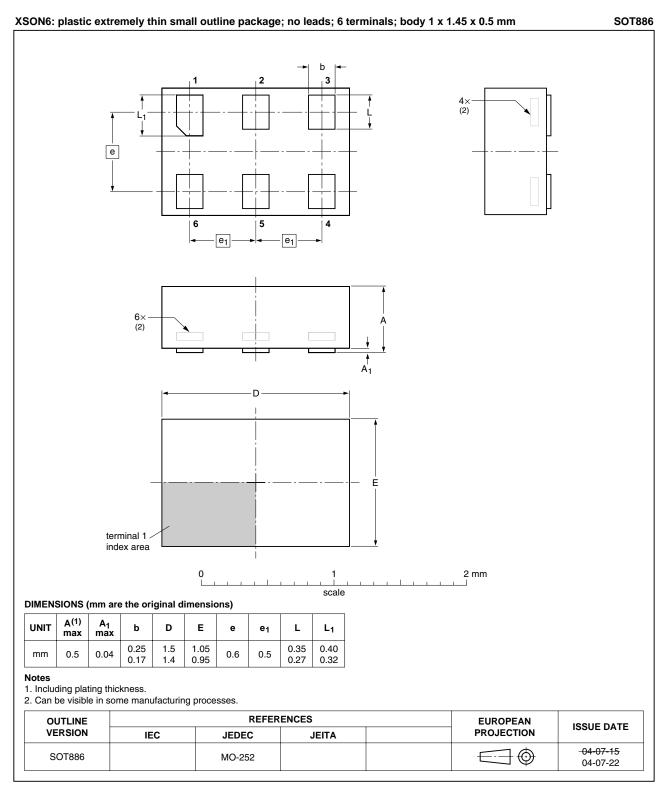


Fig 5. Package outline SOT886 (XSON-6/MO-252)

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9. Revision history

Table 8. Revision histo	ble 8. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
IP4256CZ3-M_CZ5-W_ CZ6-F v.1	20100723	Product data sheet	-	-	

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10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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